

** TEXAS INSTRUMENTS Bill of Materials

TIDA-00600

Item #	Designator	Quantity	Value	PartNumber	Manufacturer	Description	PackageReference
1	!PCB	1		TIDA-00600	Any	Printed Circuit Board	
1		2	1uF	C1005X5R1E105K050BC	TDK		0402
2	C1, C2, C3	3				CAP, CERM, 1 µF, 25 V, +/- 10%, X5R, 0402	
3	C4, C5	2	10uF	LMK212BJ106KD-T	Taiyo Yuden	CAP, CERM, 10 μF, 10 V, +/- 10%, X5R, 0805	0805
4	C6	1	10uF	GRM155R61A106ME11	MuRata	CAP, CERM, 10 μF, 10 V, +/- 20%, X5R, 0402	0402
5	D1	1	Green	LTST-C190GKT	Lite-On	LED, Green, SMD	1.6x0.8x0.8mm
6	J1, J2, J3	3	2x1	1715721	Phoenix Contact	Conn Term Block, 2POS, 5.08mm, TH	2POS Terminal Block
7	R1	1	1.50k	CRCW04021K50FKED	Vishay-Dale	RES, 1.50 k, 1%, 0.063 W, 0402	0402
8	R2	1	3.3k	CRCW04023K30JNED	Vishay-Dale	RES, 3.3 k, 5%, 0.063 W, 0402	0402
9	R3	1	56.2k	CRCW040256K2FKED	Vishay-Dale	RES, 56.2 k, 1%, 0.063 W, 0402	0402
10	R4	1	10k	ERJ-2GEJ103X	Panasonic	RES, 10 k, 5%, 0.1 W, 0402	0402
11	R5	1	0	CRCW04020000Z0ED	Vishay-Dale	RES, 0, 5%, 0.063 W, 0402	0402
12	U2	1		BQ24230RGTR	Texas Instruments	USB Friendly 0.5 A Li+ Charger with Dynamic	RGT0016C
						Ultra Low-Noise, 250-mA Linear Regulator for RF	
						and Analog Circuits - Requires No Bypass	
13	U3	1		LP5907UVX-2.8/NOPB	Texas Instruments	Capacitor, YKE0004AAAA package	YKE0004AAAA
	FID1, FID2,						
14	FID3	0		N/A	N/A	Fiducial mark. There is nothing to buy or mount.	Fiducial
						ESD in 0402 Package with 10 pF Capacitance and 6	
						V Breakdown, 1 Channel, -40 to +125 degC, 2-pin	
15	U1	0		TPD1E05U06DPYT	Texas Instruments	X2SON (DPY), Green (RoHS & no Sb/Br)	DPY0002A
						voltage supervisory , 0.9 V to 6.5 V Input, 2.93	
						threshold voltage ,4-pin X2SON (DQN), -40 to 85	
16	U5	0		TPS3839K33	Texas Instruments	degC, Green (RoHS & no Sb/Br)	DQN0004A

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